

V_R	650V
I_F	8A
Q_C	21nC

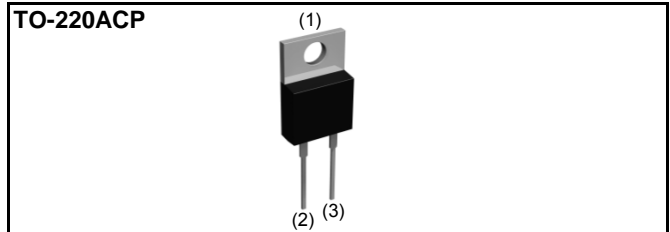
●Features

- 1) Shorter recovery time
- 2) Reduced temperature dependence
- 3) High-speed switching possible
- 4) High surge current capability

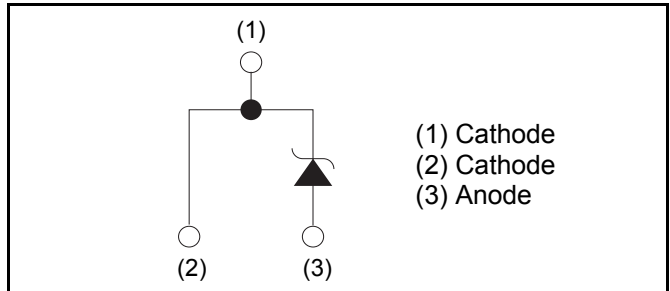
●Construction

Silicon carbide epitaxial planar type

●Outline



●Inner circuit



●Packaging specifications

Type	Packaging	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	50
	Packing code	C9
	Marking	SCS308AP

●Absolute maximum ratings ($T_j = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit	
Reverse voltage (repetitive peak)	V_{RM}	650	V	
Reverse voltage (DC)	V_R	650	V	
Continuous forward current ($T_c = 135^\circ\text{C}$)	I_F	8	A	
Surge non-repetitive forward current	I_{FSM}	PW=10ms sinusoidal, $T_j=25^\circ\text{C}$	67	A
		PW=10ms sinusoidal, $T_j=150^\circ\text{C}$	57	A
		PW=10 μs square, $T_j=25^\circ\text{C}$	250	A
Repetitive peak forward current	I_{FRM}	36 *1	A	
i^2t value	$\int i^2 dt$	$1 \leq PW \leq 10\text{ms}$, $T_j=25^\circ\text{C}$	22	A^2s
		$1 \leq PW \leq 10\text{ms}$, $T_j=150^\circ\text{C}$	16	A^2s
Total power dissipation	P_D	57 *2	W	
Junction temperature	T_j	175	$^\circ\text{C}$	
Range of storage temperature	T_{stg}	-55 to +175	$^\circ\text{C}$	

*1 $T_c=100^\circ\text{C}$, $T_j=150^\circ\text{C}$, Duty cycle=10% *2 $T_c=25^\circ\text{C}$

●Electrical characteristics ($T_j = 25^\circ\text{C}$)

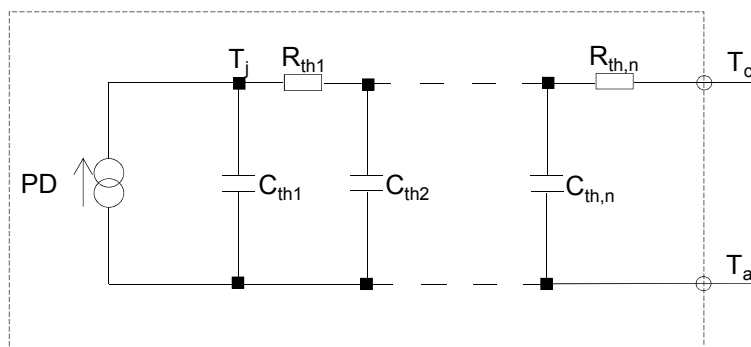
Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
DC blocking voltage	V_{DC}	$I_R = 50\mu\text{A}$	650	-	-	V
Forward voltage	V_F	$I_F = 8\text{A}, T_j = 25^\circ\text{C}$	-	1.35	1.50	V
		$I_F = 8\text{A}, T_j = 150^\circ\text{C}$	-	1.44	1.71	V
		$I_F = 8\text{A}, T_j = 175^\circ\text{C}$	-	1.50	-	V
Reverse current	I_R	$V_R = 650\text{V}, T_j = 25^\circ\text{C}$	-	0.024	40	μA
		$V_R = 650\text{V}, T_j = 150^\circ\text{C}$	-	1.6	160	μA
		$V_R = 650\text{V}, T_j = 175^\circ\text{C}$	-	4.8	-	μA
Total capacitance	C	$V_R = 1\text{V}, f = 1\text{MHz}$	-	400	-	pF
		$V_R = 650\text{V}, f = 1\text{MHz}$	-	36	-	pF
Total capacitive charge	Q_C	$V_R = 400\text{V}, di/dt = 350\text{A}/\mu\text{s}$	-	21	-	nC
Switching time	t_C	$V_R = 400\text{V}, di/dt = 350\text{A}/\mu\text{s}$	-	15	-	ns
Non-repetitive Avaranche Energy	E_{ava}	$L = 1\text{mH}$	-	110	-	mJ

●Thermal characteristics

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th(j-c)}$	-	-	1.8	2.6	$^\circ\text{C}/\text{W}$

●Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R_{th1}	1.89E-02	K/W	C_{th1}	1.95E-04	Ws/K
R_{th2}	1.81E-01		C_{th2}	8.01E-04	
R_{th3}	1.55E+00		C_{th3}	1.82E-03	



●Electrical characteristic curves

Fig.1 $V_F - I_F$ Characteristics

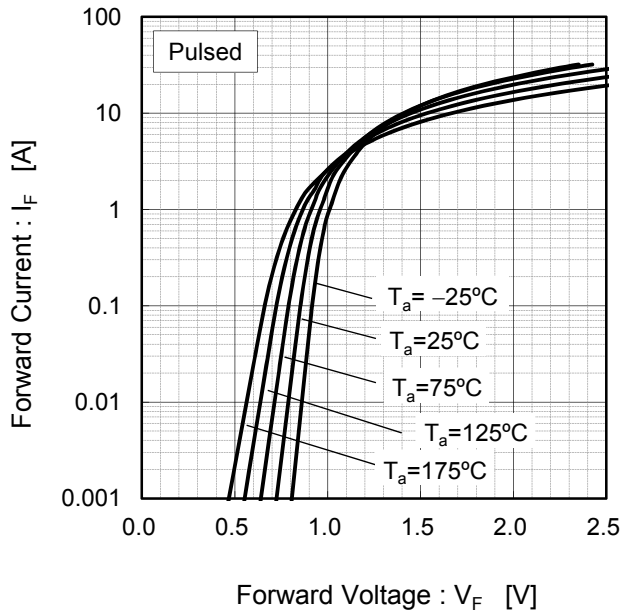


Fig.2 $V_F - I_F$ Characteristics

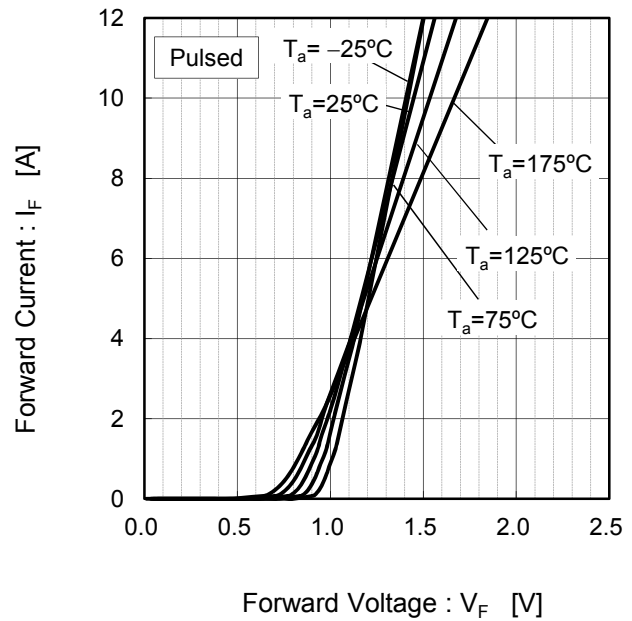


Fig.3 $V_R - I_R$ Characteristics

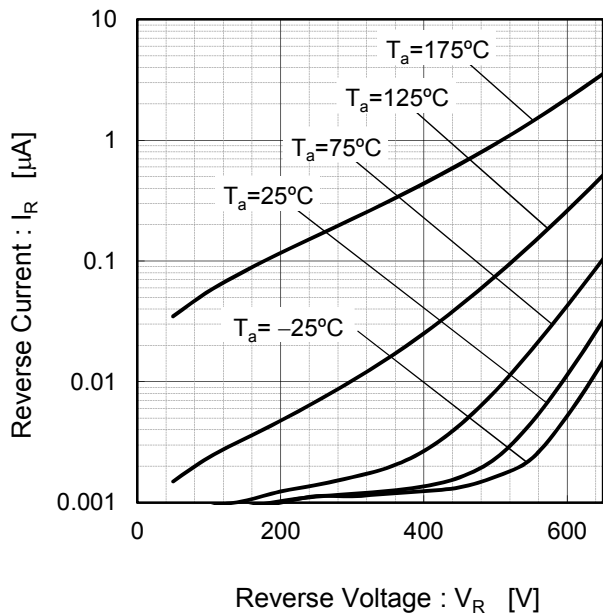
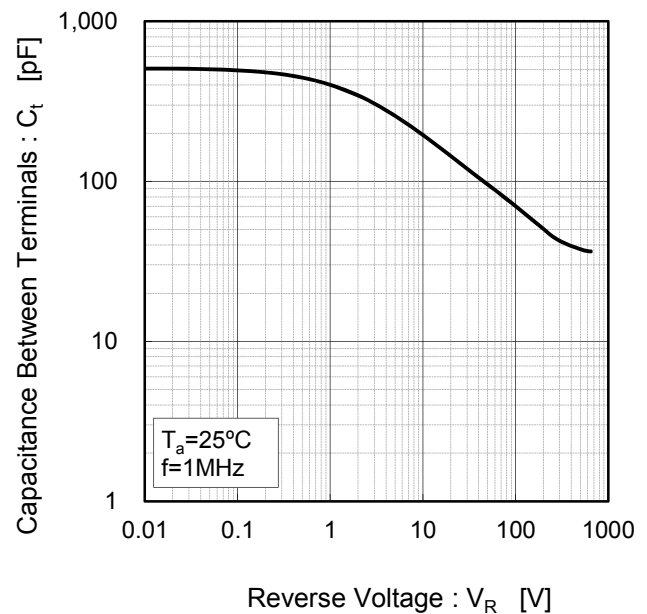


Fig.4 $V_R - C_t$ Characteristics



●Electrical characteristic curves

Fig.5 Typical Transient Thermal Resistance vs. Pulse Width

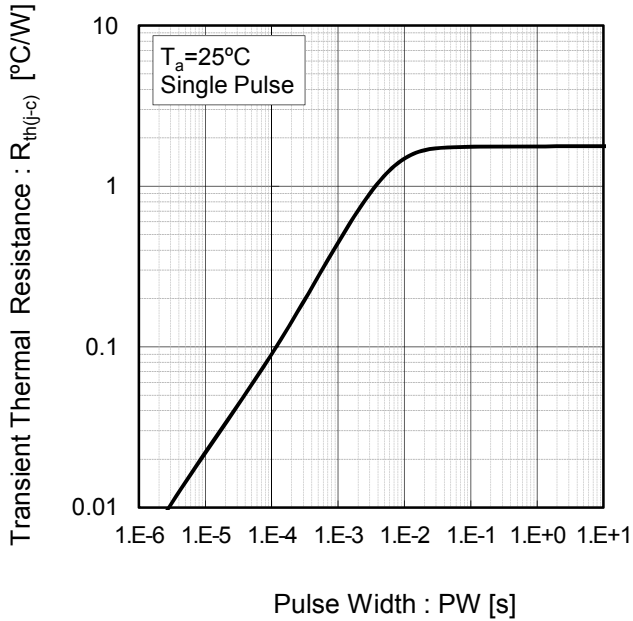


Fig.6 Power Dissipation

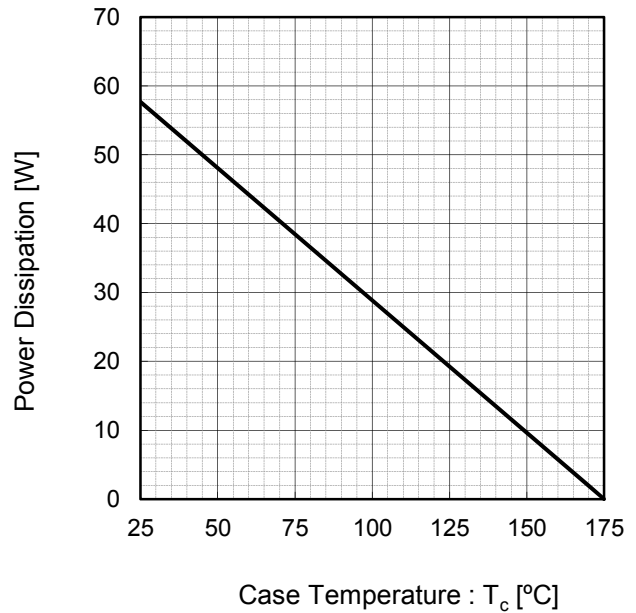
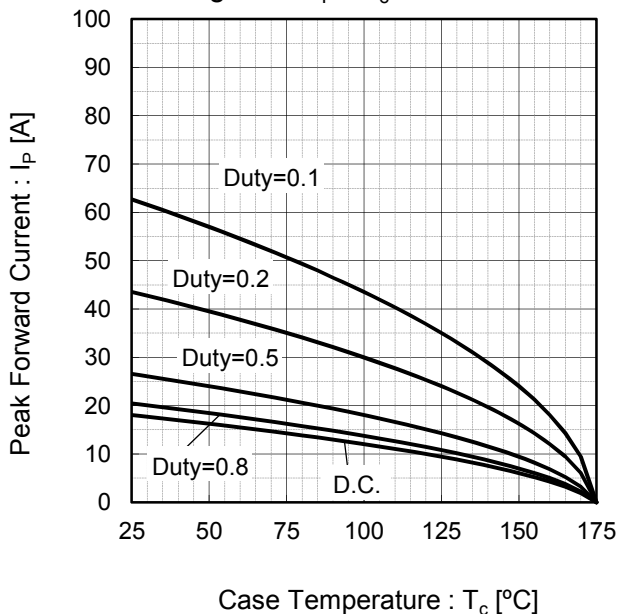
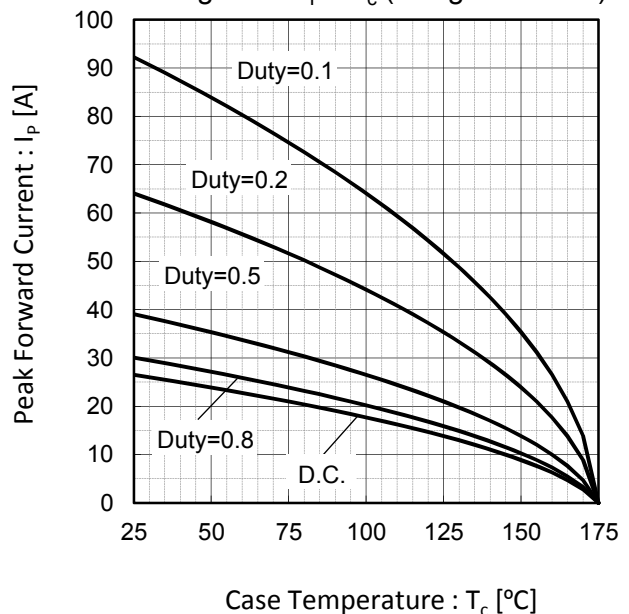


Fig.7*3 Maximum peak forward current derating curve $I_P - T_c$



*3 Based on max Vf, max $R_{th(j-c)}$
Valid for switching of above 10kHz,
excluding D.C. curve.

Fig.8*4 Typical peak forward current derating curve $I_P - T_c$ (Not guaranteed)



*4 Based on typ Vf, typ $R_{th(j-c)}$
Typical value, not guaranteed
Valid for switching of above 10kHz,
excluding D.C. curve

●Electrical characteristic curves

Fig.9 Surge non-repetitive forward current vs. Pulse width (Sinusoidal waveform)

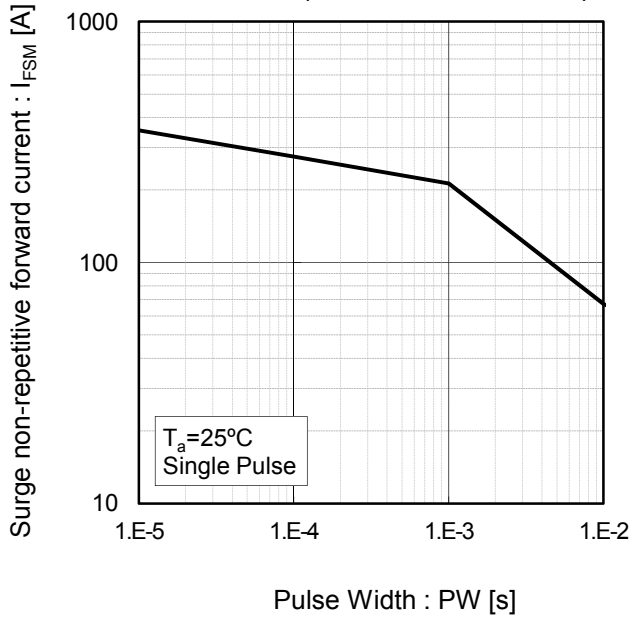
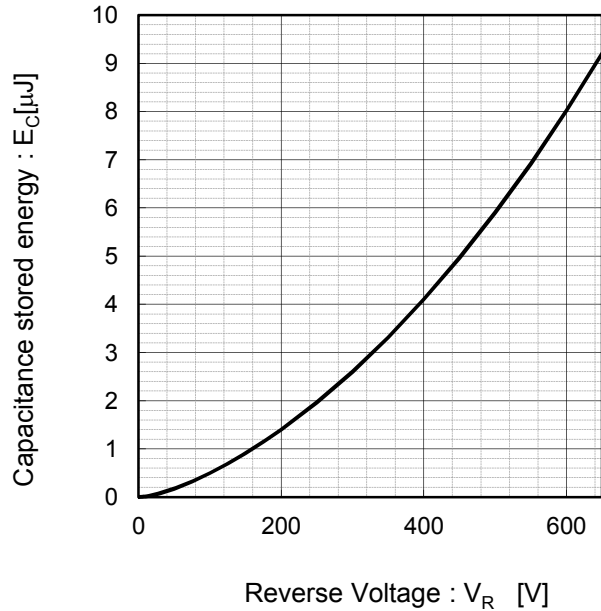
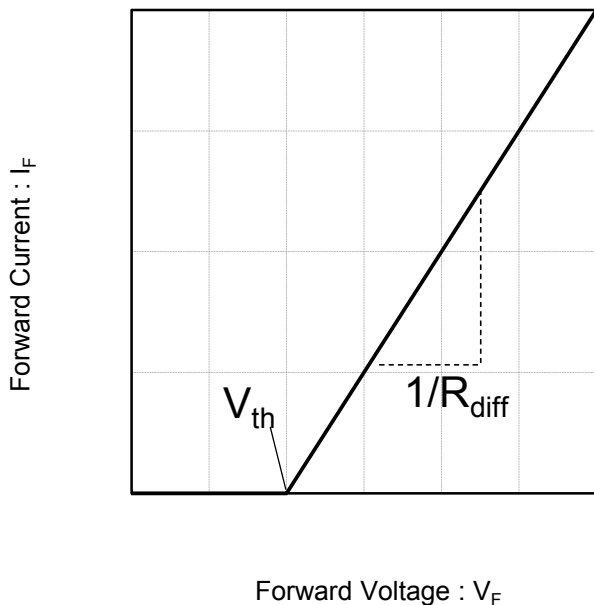


Fig.10 Typical capacitance store energy



●Simplified forward characteristic model

Fig.11 Equivalent forward current curve



$$V_F = V_{th} + R_{diff} I_F$$

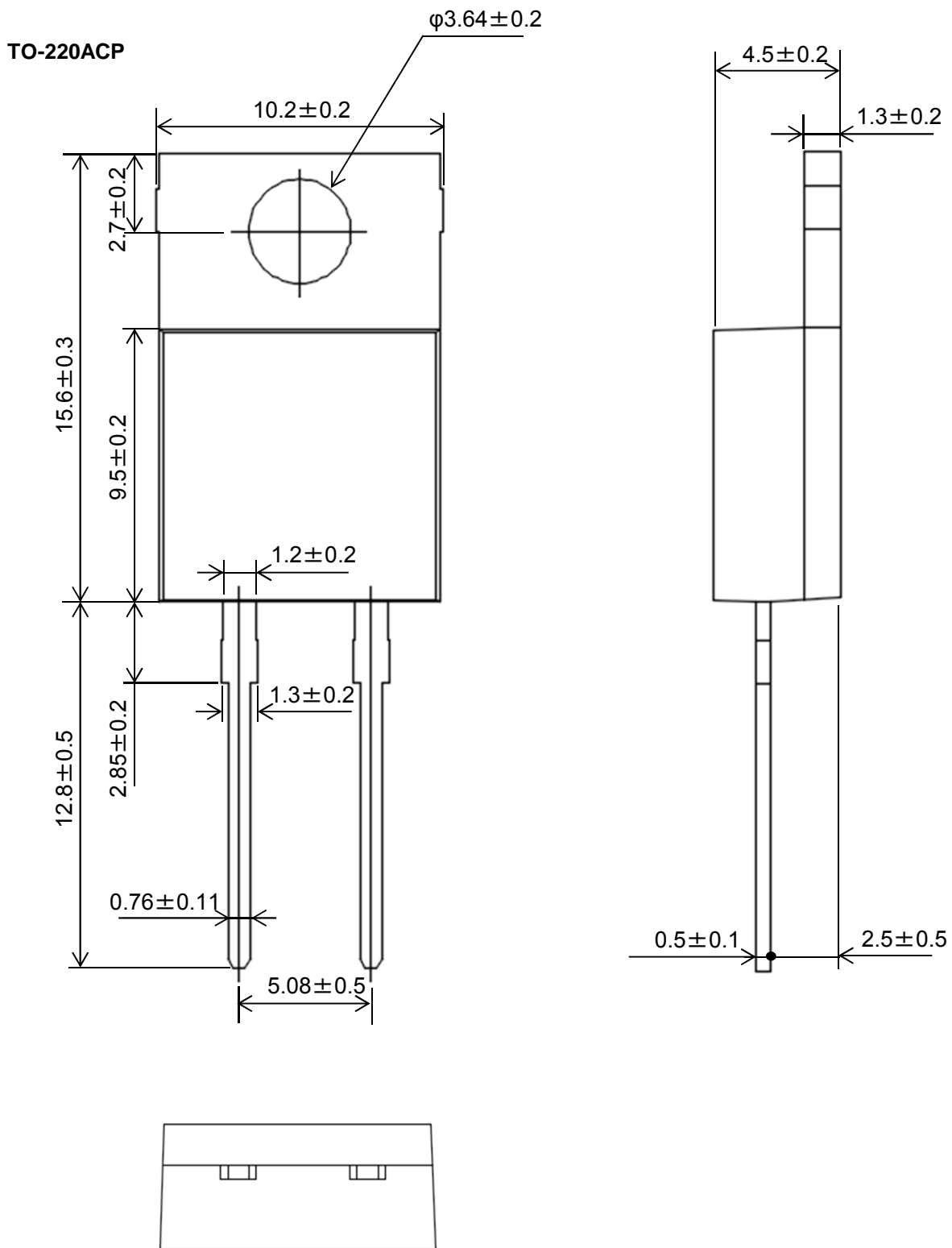
$$V_{th}(T_j) = a_0 + a_1 T_j$$

$$R_{diff}(T_j) = b_0 + b_1 T_j + b_2 T_j^2$$

Symbol	Typical Value	Unit
a ₀	9.66E-01	V
a ₁	-1.10E-03	V/°C
b ₀	4.40E-02	Ω
b ₁	9.33E-05	Ω/°C
b ₂	9.60E-07	Ω/°C ²

T_j in °C; -55 °C < T_j < 175 °C ; I_F < 16A

●Dimensions (Unit : mm)



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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